5-7-01

PATENT

Docket No. \_JCLA6212\_

Date: 5-4-200

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# ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

Sir:

Transmitted herewith for filing is the patent application of

ATTENTION: APPLICATION BRANCH

Inventors: Teng-Tang Yang, Kun-Yi Lu, Ying-Chang Chia, Jiin-Shiarng Wen

For: A PROCESS FOR FORMING A CONDUCTING STRUCTURE LAYER THAT CAN REDUCE METAL ETCHING RESIDUE

#### Enclosed are:

- Specification 13 pages.
- Recordation Form Cover sheet with 2 pages assignment.
- A certified copy of Taiwan Patent Application No. <u>89115000</u> dated <u>July</u> 27, 2000.
- SIGNED declaration and power of attorney.
- Return Prepaid postcard.

CLAIMS AS FILED							
FOR	NUMB	ER FII	ED N	NUMBEI	REXTRA	RATE	FEE
Basic Fee						\$710.00	\$710.00
Total Claims	26	_	20 =	6	×	\$18.00	\$108.00
Independent Claims	4	_	3 =	1	×	\$80.00	\$80.00
If application contains any multiple dependent claim (s), then add						\$270.00	\$0.00
TOTAL FILING FEE							\$898.00

A check in the amount of \$898.00 cover the filing fee is enclosed.

A check in the amount of \$40.00 to cover the assignment recording fee.

A duplicate copy of this sheet is enclosed.

Jiawei Huang

Registration No. 43,330

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#### **CERTIFICATE OF MAILING BY "EXPRESS MAIL"**

Docket No.

: JCLA6212

Applicant(s)

: Teng-Tang Yang, Kun-Yi Lu, Ying-Chang Chia,

Jiin-Shiarng Wen

For

: A PROCESS FOR FORMING A CONDUCTING STRUCTURE LAYER THAT CAN REDUCE METAL ETCHING RESIDUE

"Express Mail"

: EL608224266US

Mailing Label No.

**Date of Deposit** 

: May 4, 2001

I hereby certify that the accompanying

Transmittal in Duplicate; Specification 13 pages, 5 sheets of drawings; SIGNED Declaration and Power of Attorney 2 pages; Recordation Form Cover Sheet and Assignment 3 pages; Certified copy of Taiwanese Application No. 89115000; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

Jiawei Huang